

2048-word x 8-bit High Speed CMOS Static RAM

■ FEATURES

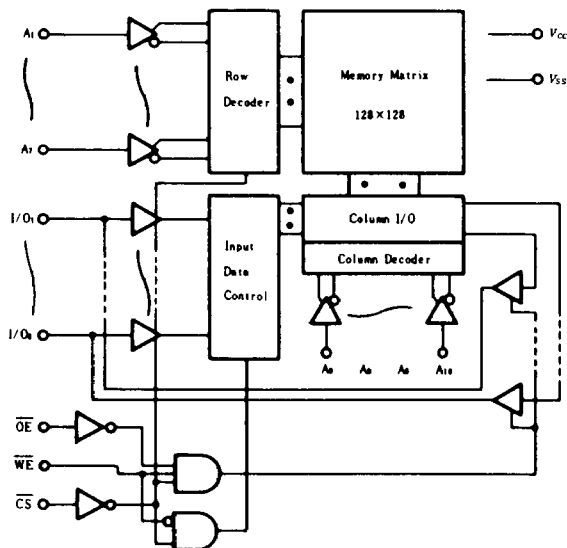
- Single 5V Supply
- High speed: Fast Access Time 120ns/150ns/200ns (max.)
- Low Power Standby and Low Power Operation

Standby:	100μW (typ.)
	10μW (typ.) (L-version)
Operation:	200mW (typ.)
	175mW (typ.) (L-version)
- Completely Static RAM: No clock or Timing Strobe Required
- Directly TTL Compatible: All Input and Output
- Pin Out Compatible with Standard 16K EPROM/MASK ROM
- Equal Access and Cycle Time
- Capability of Battery Back Up Operation (L-version)

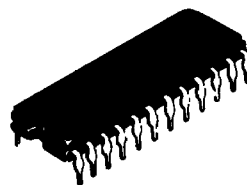
ORDERING INFORMATION

Type No.	Access Time	Package
HM6116P-2	120ns	600mil 24pin Plastic DIP
HM6116P-3	150 ns	
HM6116P-4	200 ns	
HM6116LP-2	120 ns	
HM6116LP-3	150 ns	
HM6116LP-4	200 ns	
HM6116FP-2	120 ns	24pin Plastic SOP
HM6116FP-3	150 ns	
HM6114FP-4	200 ns	
HM6116LFP-2	120 ns	
HM6116LFP-3	150 ns	
HM6116LFP-4	200 ns	

■FUNCTIONAL BLOCK DIAGRAM



HM6116P Series



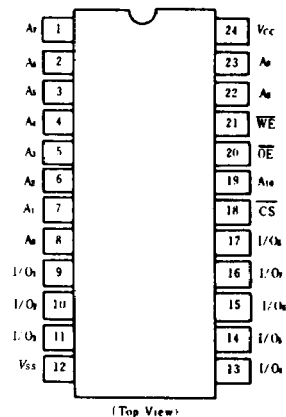
(DP-24)

HM6116FP Series



(FP-24D)

■ PIN ARRANGEMENT



Note) This device is not available for new application.

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on Any Pin Relative to V_{SS}	V_I	-0.5*1 to +7.0	V
Operating Temperature	T_{op}	0 to +70	°C
Storage Temperature	T_{stg}	-55 to +125	°C
Storage Temperature Under Bias	T_{mb}	-10 to +85	°C
Power Dissipation	P_T	1.0	W

Note) *1. -3.5V for pulse width ≤ 50 ns

■ TRUTH TABLE

$\overline{CS}$	$\overline{OE}$	$\overline{WE}$	Mode	V_{CC} Current	I/O Pin	Ref. Cycle
H	x	x	Not Selected	I_{SB}, I_{SB1}	High Z	
L	L	H	Read	I_{CC}	Dout	Read Cycle (1)~(3)
L	H	L	Write	I_{CC}	Din	Write Cycle (1)
L	L	L	Write	I_{CC}	Din	Write Cycle (2)

■ RECOMMENDED DC OPERATING CONDITIONS ($T_a=0$ to +70°C)

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}	4.5	5.0	5.5	V
	V_{SS}	0	0	0	V
Input Voltage	V_{IH}	2.2	3.5	6.0	V
	V_{IL}	-0.3*1	—	0.8	V

Note) *1. -3.0V for pulse width ≤ 50 ns.

■ DC AND OPERATING CHARACTERISTICS ($V_{CC}=5V \pm 10\%$, $V_{SS}=0V$, $T_a=0$ to +70°C)

Item	Symbol	Test Conditions	HM6116-2			HM6116-3/-4			Unit
			min	typ*1	max	min	typ*1	max	
Input Leakage Current	$ I_{LI} $	$V_{CC}=5.5V$, $V_{IN}=V_{SS}$ to V_{CC}	—	—	10	—	—	10	μA
			—	—	2*3	—	—	2*3	
Output Leakage Current	$ I_{LO} $	$\overline{CS}=V_{IH}$ or $\overline{OE}=V_{IN}$, $V_{I/O}=V_{SS}$ to V_{CC}	—	—	10	—	—	10	μA
			—	—	2*3	—	—	2*3	
Operating Power Supply Current	I_{CC}	$\overline{CS}=V_{IL}$, $I_{I/O}=0mA$	—	40	80	—	35	70	mA
			—	35*3	70*3	—	30*3	60*3	
	I_{CC1} *2	$V_{IH}=3.5V$, $V_{IL}=0.6V$, $I_{I/O}=0mA$	—	35	—	—	30	—	mA
			—	30*3	—	—	25*3	—	
Average Operating Current	I_{CC2}	Min. cycle, duty=100% $I_{I/O}=0mA$	—	40	80	—	35	70	mA
			—	35*3	70*3	—	30*3	60*3	
Standby Power Supply Current	I_{SB}	$\overline{CS}=V_{IH}$	—	5	15	—	5	15	mA
			—	4*3	12*3	—	4*3	12*3	
	I_{SB1}	$\overline{CS} \geq V_{CC} - 0.2V$, $0V \leq V_{IN} \leq 0.2V$ or $V_{CC} - 0.2V \leq V_{IN}$	—	0.02	2	—	0.02	2	μA
			—	2*3	50*3	—	2*3	50*3	
Output Voltage	V_{OL}	$I_{OL}=4mA$	—	—	0.4	—	—	—	V
		$I_{OL}=2.1mA$	—	—	—	—	—	0.4	V
	V_{OH}	$I_{OH}=-1.0mA$	2.4	—	—	2.4	—	—	V

Notes) *1. $V_{CC}=5V$, $T_a=25^\circ C$

*2. Reference Only

*3. This characteristics are guaranteed only for L-version.



CAPACITANCE ($f=1\text{MHz}$, $T_a=25^\circ\text{C}$)

Item	Symbol	Test Conditions	typ	max	Unit
Input Capacitance	C_{in}	$V_{in}=0\text{V}$	3	5	pF
Input/Output Capacitance	C_{Lo}	$V_{Lo}=0\text{V}$	5	7	pF

Note) This parameter is sampled and not 100% tested.

AC CHARACTERISTICS ($V_{CC}=5\text{V}\pm 10\%$, $T_a=0$ to $+70^\circ\text{C}$)

AC TEST CONDITIONS

Input Pulse Levels: 0.8 to 2.4V

Input Rise and Fall Times: 10 ns

Input and Output Timing Reference Levels: 1.5V

Output Load: 1TTL Gate and C_L (100pF) (including scope and jig)

READ CYCLE

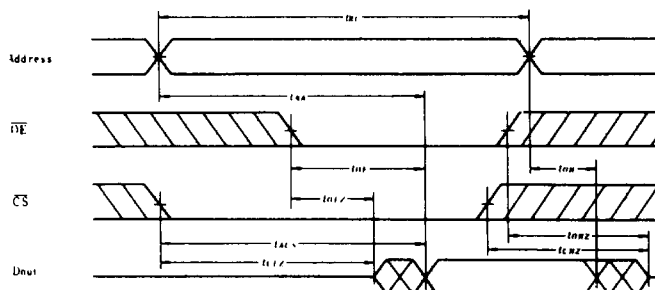
Item	Symbol	HM6116-2		HM6116-3		HM6116-4		Unit
		min	max	min	max	min	max	
Read Cycle Time	t_{RC}	120	—	150	—	200	—	ns
Address Access Time	t_{AA}	—	120	—	150	—	200	ns
Chip Select Access Time	t_{ACS}	—	120	—	150	—	200	ns
Chip Selection to Output in Low Z	t_{CLZ}	10	—	15	—	15	—	ns
Output Enable to Output Valid	t_{OE}	—	80	—	100	—	120	ns
Output Enable to Output in Low Z	t_{OLZ}	10	—	15	—	15	—	ns
Chip Deselection to Output in High Z	t_{CHZ}	0	40	0	50	0	60	ns
Chip Disable to Output in High Z	t_{ONZ}	0	40	0	50	0	60	ns
Output Hold from Address Change	t_{OH}	10	—	15	—	15	—	ns

WRITE CYCLE

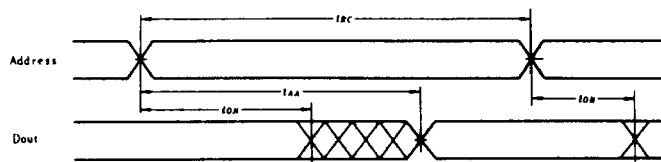
Item	Symbol	HM6116-2		HM6116-3		HM6116-4		Unit
		min	max	min	max	min	max	
Write Cycle Time	t_{WC}	120	—	150	—	200	—	ns
Chip Selection to End of Write	t_{CW}	70	—	90	—	120	—	ns
Address Valid to End of Write	t_{AW}	105	—	120	—	140	—	ns
Address Set Up Time	t_{AS}	20	—	20	—	20	—	ns
Write Pulse Width	t_{WP}	70	—	90	—	120	—	ns
Write Recovery Time	t_{WR}	5	—	10	—	10	—	ns
Output Disable to Output in High Z	t_{ONZ}	0	40	0	50	0	60	ns
Write to Output in High Z	t_{WHz}	0	50	0	60	0	60	ns
Data to Write Time Overlap	t_{OW}	35	—	40	—	60	—	ns
Data Hold from Write Time	t_{OH}	5	—	10	—	10	—	ns
Output Active from End of Write	t_{OW}	5	—	10	—	10	—	ns

TIMING WAVEFORM

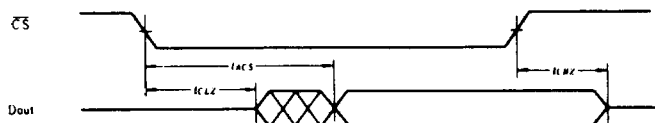
READ CYCLE (1) ⁽¹⁾



● READ CYCLE (2) ⁽¹⁾⁽²⁾⁽⁴⁾

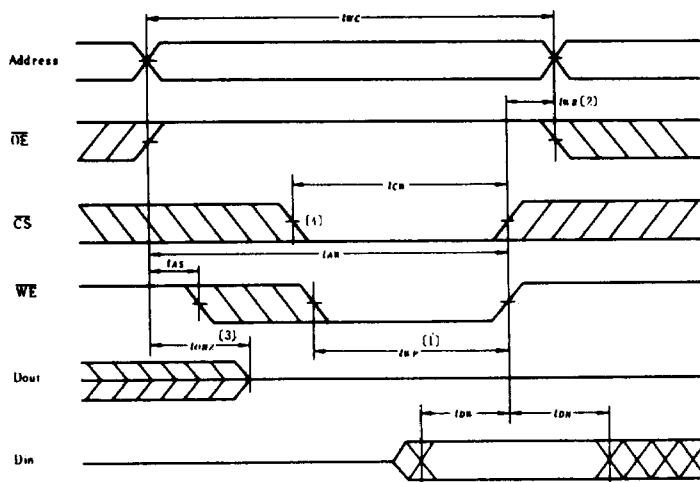


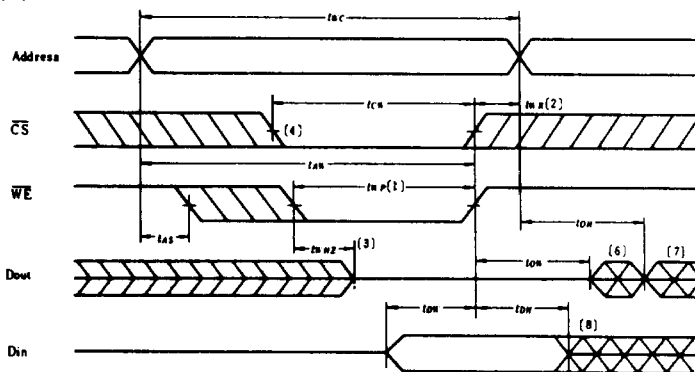
● READ CYCLE (3) ⁽¹⁾⁽²⁾⁽⁴⁾



- NOTES:
1. $\overline{WE}$ is High for Read Cycle.
 2. Device is continuously selected, $\overline{CS} = V_{IL}$.
 3. Address Valid prior to or coincident with $\overline{CS}$ transition Low.
 4. $\overline{OE} = V_{IL}$.

● WRITE CYCLE (1)



● WRITE CYCLE (2)⁽³⁾

- NOTES:
1. A write occurs during the overlap (t_{WP}) of a low $\overline{CS}$ and a low $\overline{WE}$.
 2. t_{WP} is measured from the earlier of $\overline{CS}$ or $\overline{WE}$ going high to the end of write cycle.
 3. During this period, I/O pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
 4. If the $\overline{CS}$ low transition occurs simultaneously with the $\overline{WE}$ low transitions or after the $\overline{WE}$ transition, output remain in a high impedance state.
 5. $\overline{OE}$ is continuously low. ($\overline{OE} = V_{IL}$)
 6. D_{out} is the same phase of write data of this write cycle.
 7. D_{out} is the read data of next address.
 8. If $\overline{CS}$ is Low during this period, I/O pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.

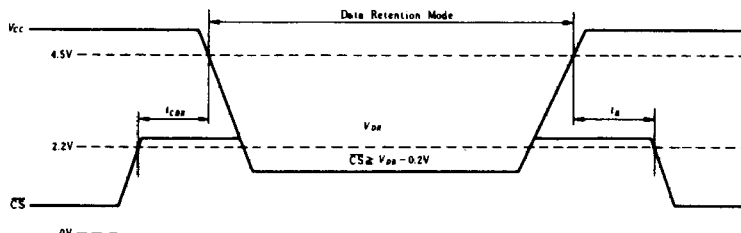
■ LOW V_{CC} DATA RETENTION CHARACTERISTICS ($T_a = 0$ to $+70^\circ\text{C}$)

This characteristics are guaranteed only for L-version.

Item	Symbol	Test Conditions	min	typ	max	Unit
V_{CC} for Data Retention	V_{DR}	$\overline{CS} \geq V_{CC} - 0.2\text{V}$, $V_{IL} \geq V_{CC} - 0.2\text{V}$ or $V_{IL} \leq 0.2\text{V}$	2.0	—	—	V
Data Retention Current	I_{CCDR}^{*1}	$V_{CC} = 3.0\text{V}$, $\overline{CS} \geq 2.8\text{V}$, $V_{IH} \geq 2.8\text{V}$ or $0\text{V} \leq V_{IN} \leq 0.2\text{V}$	—	—	30	μA
Chip Deselect to Data Retention Time	t_{CDR}	See Retention Waveform	0	—	—	ns
Operation Recovery Time	t_R		t_{AC}^{*2}	—	—	ns

Notes) *1. $10\mu\text{A}$ max at $T_a = 0^\circ\text{C}$ to $+40^\circ\text{C}$, V_{IL} min = -0.3V

*2. t_{AC} = Read Cycle Time.

● Low V_{CC} Data Retention Waveform



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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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